$4 \text{ M SRAM} (512\text{-kword} \times 8\text{-bit})$

HITACHI

ADE-203-1258A (Z) Rev. 1.0 Jul. 23, 2001

Description

The Hitachi HM62V8512CTS Series is a 4-Mbit static RAM organized 512-kword × 8-bit. HM62V8512CTS Series has realized higher density, higher performance and low power consumption by employing CMOS process technology (6-transistor memory cell). It offers low power standby power dissipation; therefore, it is suitable for battery backup system. It is packaged in TSOP I is available for high density surface mounting.

Features

• Single 3.0 V supply: 2.7 V to 3.6 V

• Access time: 55/70 ns (max)

Power dissipation

— Active: 6.0 mW/MHz (typ)

— Standby: 2.4 μW (typ)

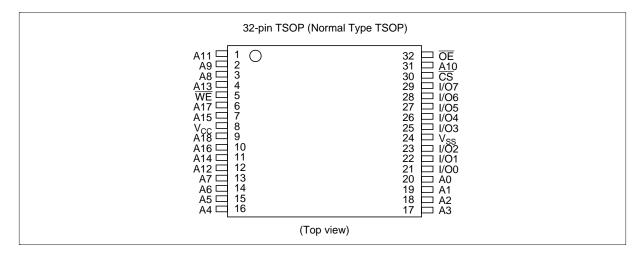
- Completely static memory. No clock or timing strobe required
- Equal access and cycle times
- Common data input and output: Three state output
- Directly LV-TTL compatible: All inputs
- Battery backup operation



Ordering Information

Type No.	Access time	Package
HM62V8512CLTS-5 HM62V8512CLTS-7	55 ns 70 ns	$8 \times 13.4 \text{ mm } 32\text{-pin plastic TSOPI (TFP-32DC)}$
HM62V8512CLTS-5SL HM62V8512CLTS-7SL		

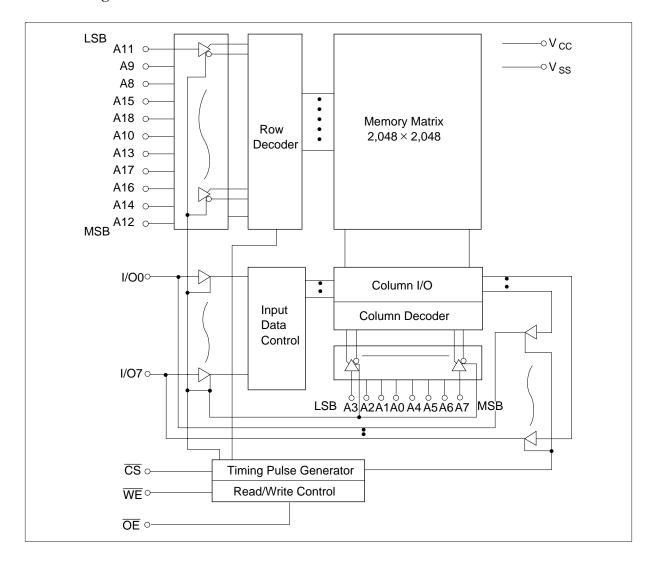
Pin Arrangement



Pin Description

Pin name	Function
A0 to A18	Address input
I/O0 to I/O7	Data input/output
CS	Chip select
ŌĒ	Output enable
WE	Write enable
V _{cc}	Power supply
V _{SS}	Ground
NC	No connection

Block Diagram



Function Table

WE	CS	OE	Mode	V _{cc} current	Dout pin	Ref. cycle
×	Н	×	Not selected	I_{SB}, I_{SB1}	High-Z	_
Н	L	Н	Output disable	I _{cc}	High-Z	_
Н	L	L	Read	I _{cc}	Dout	Read cycle
L	L	Н	Write	I _{cc}	Din	Write cycle (1)
L	L	L	Write	I _{cc}	Din	Write cycle (2)

Note: x: H or L

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage	V _{cc}	-0.5 to +4.6	V
Voltage on any pin relative to V _{ss}	V _T	-0.5^{*1} to $V_{CC} + 0.5^{*2}$	V
Power dissipation	P _T	1.0	W
Operating temperature	Topr	-20 to +70	°C
Storage temperature	Tstg	-55 to +125	°C
Storage temperature under bias	Tbias	-20 to +85	°C

Notes: 1. V_T min: -3.0 V for pulse half-width ≤ 30 ns.

2. Maximum voltage is 4.6 V.

Recommended DC Operating Conditions (Ta = -20 to +70°C)

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{cc}	2.7	3.0	3.6	V
	V _{SS}	0	0	0	V
Input high voltage	V_{IH}	2.0	_	$V_{cc} + 0.3$	V
Input low voltage	V _{IL}	-0.3*1	<u> </u>	0.8	V

Note: 1. V_{IL} min: -3.0 V for pulse half-width ≤ 30 ns.

DC Characteristics

Parameter		Symbol	Min	Typ*1	Max	Unit	Test conditions
Input leakage current		I _{LI}	_	_	1	μΑ	Vin = V _{SS} to V _{CC}
Output leakage current		I _{LO}	_	_	1	μΑ	$\overline{\text{CS}} = \text{V}_{\text{IH}} \text{ or } \overline{\text{OE}} = \text{V}_{\text{IH}} \text{ or } \overline{\text{WE}} = \text{V}_{\text{IL}}, \text{V}_{\text{I/O}} = \text{V}_{\text{SS}} \text{ to V}_{\text{CC}}$
Operating power supply current: DC		I _{cc}	_	5	10	mA	$\overline{\text{CS}} = \text{V}_{\text{IL}},$ others = $\text{V}_{\text{IH}}/\text{V}_{\text{IL}}, \text{I}_{\text{I/O}} = 0$ mA
Operating power supply current	HM62V8512CTS-5	I _{CC1}		8	25	mA	$\frac{\text{Min cycle, duty} = 100\%}{\overline{\text{CS}}} = \text{V}_{\text{IL}}, \text{ others} = \text{V}_{\text{IH}}/\text{V}_{\text{IL}}$ $\text{I}_{\text{I/O}} = 0 \text{ mA}$
	HM62V8512CTS-7	I _{CC1}	_	7	25	mA	
		I _{CC2}	_	2	5	mA	$\begin{split} &\text{Cycle time} = 1 \text{ µs,} \\ &\text{duty} = 100\% \\ &\text{I}_{\text{I/O}} = 0 \text{ mA, } \overline{\text{CS}} \leq 0.2 \text{ V} \\ &\text{V}_{\text{IH}} \geq \text{V}_{\text{CC}} - 0.2 \text{ V,} \\ &\text{V}_{\text{IL}} \leq 0.2 \text{ V} \end{split}$
Standby power supply co	urrent: DC	I _{SB}	_	0.1	0.3	mA	CS = V _{IH}
Standby power supply co	urrent (1): DC	I _{SB1}	_	0.8*2	20*2	μΑ	$\frac{\text{Vin} \ge 0 \text{ V,}}{\text{CS}} \ge \text{V}_{\text{CC}} - 0.2 \text{ V}$
			_	0.8*3	10*3	μΑ	
Output low voltage		V _{OL}		_	0.4	V	I _{OL} = 2.1 mA
			_	_	0.2	V	Ι _{ΟL} = 100 μΑ
Output high voltage		V _{OH}	V _{cc} - 0.2		_	V	I _{OH} = -100 μA
			2.4	_	_	V	$I_{OH} = -1.0 \text{ mA}$

Notes: 1. Typical values are at $V_{cc} = 3.0 \text{ V}$, $Ta = +25^{\circ}\text{C}$ and specified loading, and not guaranteed.

- 2. This characteristics is guaranteed only for L version.
- 3. This characteristics is guaranteed only for L-SL version.

Capacitance (Ta = +25°C, f = 1 MHz)

Parameter	Symbol	Тур	Max	Unit	Test conditions
Input capacitance*1	Cin	_	8	pF	Vin = 0 V
Input/output capacitance*1	C _{I/O}		10	pF	$V_{I/O} = 0 V$

Note: 1. This parameter is sampled and not 100% tested.

AC Characteristics (Ta = -20 to +70°C, $V_{CC} = 2.7$ V to 3.6 V, unless otherwise noted.)

Test Conditions

• Input pulse levels: 0.4 V to 2.4 V

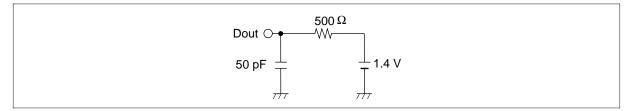
• Input rise and fall time: 5 ns

• Input timing reference levels: 1.4 V

• Output timing reference level: 1.4 V/1.4 V(HM62V8512CTS-5)

0.8 V/2.0 V(HM62V8512CTS-7)

• Output load: See figure (Including scope & jig)



Read Cycle

		-5		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Read cycle time	t _{RC}	55	_	70	_	ns	
Address access time	t _{AA}	_	55	_	70	ns	
Chip select access time	t _{co}		55		70	ns	
Output enable to output valid	t _{OE}	_	30		35	ns	
Chip selection to output in low-Z	t _{LZ}	10	_	10	_	ns	2
Output enable to output in low-Z	t _{OLZ}	5		5	<u> </u>	ns	2
Chip deselection to output in high-Z	t _{HZ}	0	20	0	30	ns	1, 2
Output disable to output in high-Z	t _{OHZ}	0	20	0	30	ns	1, 2
Output hold from address change	t _{oH}	10	_	10	_	ns	

Write Cycle

HM62V8512CTS

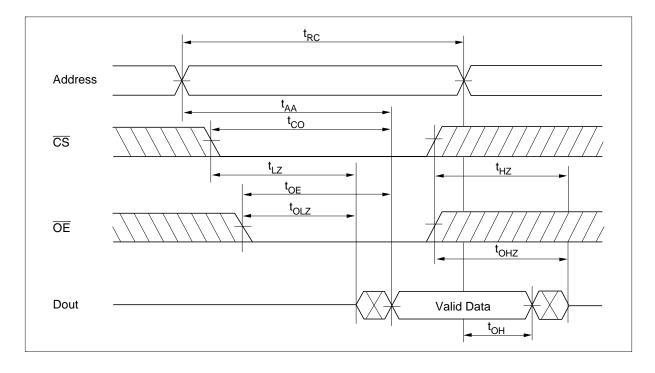
		-5		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Write cycle time	t _{wc}	55	_	70	_	ns	
Chip selection to end of write	t _{cw}	50	_	60		ns	4
Address setup time	t _{AS}	0	_	0	_	ns	5
Address valid to end of write	t _{AW}	50		60	-	ns	
Write pulse width	t _{WP}	40	_	50	_	ns	3, 12
Write recovery time	t _{WR}	0	_	0	_	ns	6
WE to output in high-Z	t _{whz}	0	20	0	30	ns	1, 2, 7
Data to write time overlap	t _{DW}	25	_	30	_	ns	
Data hold from write time	t _{DH}	0	_	0	_	ns	
Output active from output in high-Z	t _{ow}	5	_	5		ns	2
Output disable to output in high-Z	t _{OHZ}	0	20	0	30	ns	1, 2, 7

Notes: 1. t_{HZ} , t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

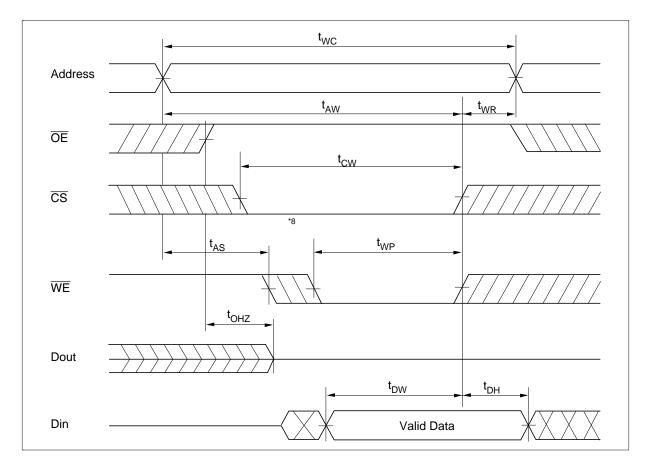
- 2. This parameter is sampled and not 100% tested.
- 3. A write occurs during the overlap (t_{WP}) of a low \(\overline{CS}\) and a low \(\overline{WE}\). A write begins at the later transition of \(\overline{CS}\) going low or \(\overline{WE}\) going low. A write ends at the earlier transition of \(\overline{CS}\) going high or \(\overline{WE}\) going high. t_{WP} is measured from the beginning of write to the end of write.
- 4. t_{CW} is measured from $\overline{\text{CS}}$ going low to the end of write.
- 5. t_{AS} is measured from the address valid to the beginning of write.
- 6. t_{WR} is measured from the earlier of \overline{WE} or \overline{CS} going high to the end of write cycle.
- 7. During this period, I/O pins are in the output state so that the input signals of the opposite phase to the outputs must not be applied.
- 8. If the $\overline{\text{CS}}$ low transition occurs simultaneously with the $\overline{\text{WE}}$ low transition or after the $\overline{\text{WE}}$ transition, the output remain in a high impedance state.
- 9. Dout is the same phase of the write data of this write cycle.
- 10. Dout is the read data of next address.
- 11. If \overline{CS} is low during this period, I/O pins are in the output state. Therefore, the input signals of the opposite phase to the outputs must not be applied to them.
- 12. In the write cycle with \overline{OE} low fixed, t_{WP} must satisfy the following equation to avoid a problem of data bus contention. $t_{WP} \ge t_{DW}$ min + t_{WHZ} max

Timing Waveforms

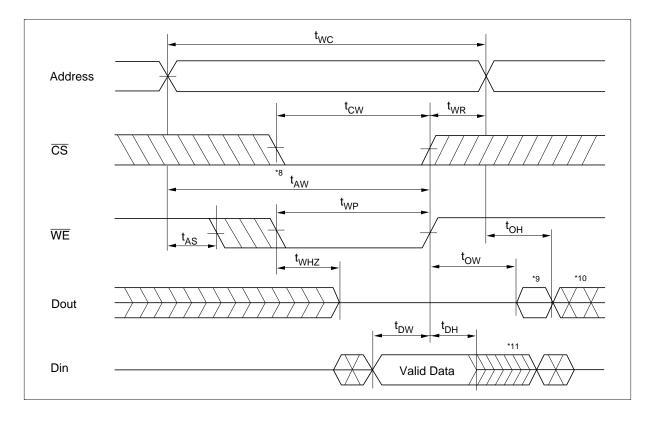
Read Timing Waveform $(\overline{WE}=V_{IH})$



Write Timing Waveform (1) $(\overline{OE} \operatorname{Clock})$



Write Timing Waveform (2) $(\overline{OE} Low Fixed)$



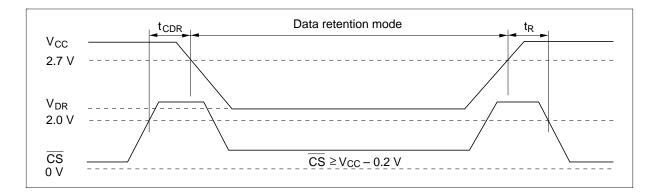
Low V_{CC} **Data Retention Characteristics** (Ta = -20 to +70°C)

Parameter	Symbol	Min	Тур	Max	Unit	Test conditions*3
V _{cc} for data retention	V_{DR}	2	_	_	V	$\overline{\text{CS}} \ge \text{V}_{\text{CC}} - 0.2 \text{ V, Vin} \ge 0 \text{ V}$
Data retention current	I _{CCDR}	_	0.8*4	20*1	μΑ	$\frac{V_{CC}}{CS} = 3.0 \text{ V}, \text{ Vin } \ge 0 \text{ V}$ $\frac{V_{CC}}{CS} \ge V_{CC} - 0.2 \text{ V}$
		_	0.8*4	10*2	μA	_
Chip deselect to data retention time	t _{CDR}	0	_		ns	See retention waveform
Operation recovery time	t _R	t _{RC} *5	_	_	ns	

Notes: 1. For L-version and 10 μ A (max.) at Ta = -20 to +40°C.

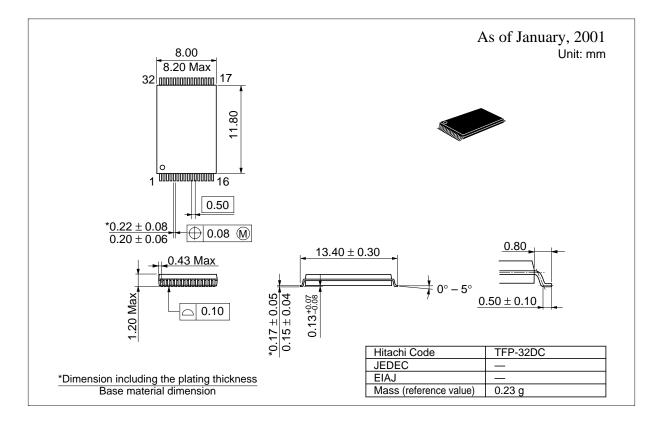
- 2. For L-SL-version and 3 μ A (max.) at Ta = -20 to +40°C.
- 3. $\overline{\text{CS}}$ controls address buffer, $\overline{\text{WE}}$ buffer, $\overline{\text{OE}}$ buffer, and Din buffer. In data retention mode, Vin levels (address, $\overline{\text{WE}}$, $\overline{\text{OE}}$, I/O) can be in the high impedance state.
- 4. Typical values are at V_{cc} = 3.0 V, Ta = +25°C and specified loading, and not guaranteed.
- 5. t_{RC} = read cycle time.

Low V_{CC} Data Retention Timing Waveform (\overline{CS} Controlled)



Package Dimensions

HM62V8512CLTS Series (TFP-32DC)



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